



Product/Process Change Notice - PCN 22_0246 Rev. -

Analog Devices, Inc. One Analog Way, Wilmington, MA 01887, USA

This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. **Any inquiries or requests with this PCN (additional data or samples) must be sent to ADI within 30 days of publication date.** ADI contact information is listed below.

PCN Title: HMC-ALH445 Die Data Sheet Limit Revision

Publication Date: 07-Oct-2022

Effectivity Date: 21-Oct-2022 *(the earliest date that a customer could expect to receive changed material)*

Revision Description:
Initial Release.

Description Of Change:

Change the thermal resistance listed in the AMR table on Page 3 from 201.2 Deg C/W to 124 deg C/W.

Reason For Change:

The data sheet is being changed to accurately reflect the device's capabilities.

Impact of the change (positive or negative) on fit, form, function & reliability:

No impact on fit, form, or functionality of the device.

Summary of Supporting Information:

Changes will be reflected in Product Data Sheet Rev v04.1022.

Supporting Documents

Attachment 1: Type: Datasheet Specification Comparison

ADI_PCN_22_0246_Rev_-_HMC-ALH445_spec_ccomparison.pdf

For questions on this PCN, please send an email to the regional contacts below or contact your local ADI sales representatives.

Americas:
PCN_Americas@analog.com

Europe:
PCN_Europe@analog.com

Japan:
PCN_Japan@analog.com

Rest of Asia:
PCN_ROA@analog.com

Appendix A - Affected ADI Models				
Added Parts On This Revision - Product Family / Model Number (1)				
HMC-ALH445G / HMC-ALH445				

Appendix B - Revision History			
Rev	Publish Date	Effectivity Date	Rev Description
Rev. -	07-Oct-2022	21-Oct-2022	Initial Release.

Analog Devices, Inc.

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